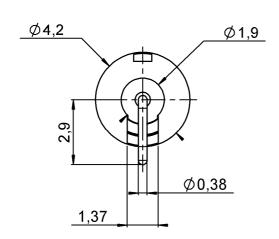
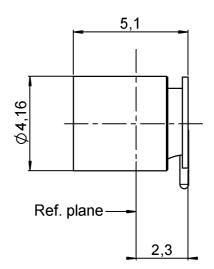
SMT TYPE - LIMITED DETENT - REEL 500

R222.508.300

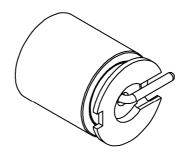
Series: SMP







Scale 1:1



All dimensions are in mm.



COMPONENTS	MATERIALS	PLATINGS (μm)
BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS -	STAINLESS STEEL + BRASS BERYLLIUM COPPER - PTFE	PASSIVATED + GOLD 0.5 OVER NICKEL 2 GOLD 1.27 OVER NICKEL 1.27

Issue: 0831 C

In the effort to improve our products, we reserve the right to make changes judged to be necessary.



R222.508.300

SMT TYPE - LIMITED DETENT - REEL 500

Series: SMP

PACKAGING

Standard Unit Other 500 'W' option Contact us

SPECIFICATION

ELECTRICAL CHARACTERISTICS

Impedance 50Ω

Frequency 0-12 GHz

VSWR 1.15 + 0,0000 x F(GHz) Maxi

Insertion loss 0.12 \(\sqrt{F(GHz)} \) dB Maxi

RF leakage - (NA - F(GHz)) dB Maxi Voltage rating 335 Veff Maxi

Voltage rating
Dielectric withstanding voltage
Insulation resistance $500 \quad \text{Veff mini}$ $5000 \quad \text{M}\Omega \text{ mini}$

ENVIRONMENTAL

Operating temperature -65/+165 ° C

Hermetic seal NA Atm.cm3/s

Panel leakage NA

OTHERS CHARACTERISTICS

Assembly instruction

Others:

Compliant with MIL-STD-348

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

6.8 N mini
6.8 N mini
NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 500 Cycles mini

Weight **0,3200** g

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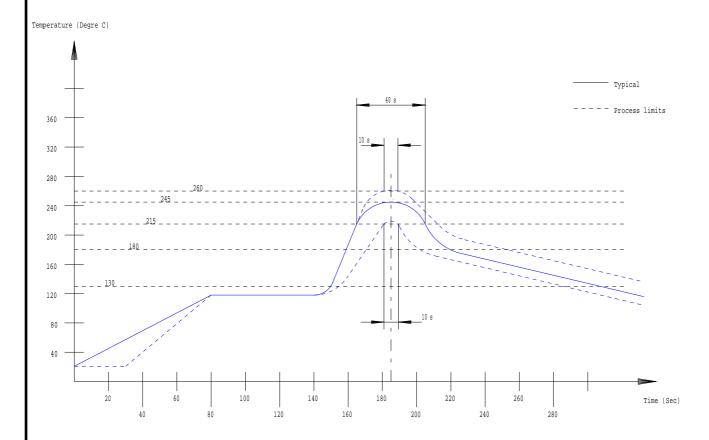
SMT TYPE - LIMITED DETENT - REEL 500

Series: SMP

SOLDER PROCEDURE

- 1. Deposit solder paste 'Sn62Pb36Ag2' on mounting zone by screen printing application. We recommend a low residue flux.
 - We advise a thickness of 150 micrometers (.0059 inches). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.
 - Video camera is preferred to check the positioning of the component. Adhesive agents are forbidden on the receptacle.
- 3. Soldering by infrared reflow.
- 4. Clean printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.

TEMPERATURE PROFILE



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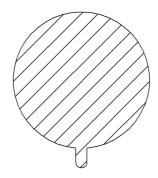


SMT TYPE - LIMITED DETENT - REEL 500

R222.508.300

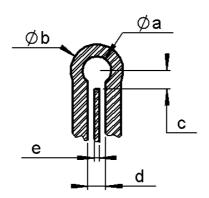
Series: SMP

SHADOW OF THE RECEPTACLE



FOR VIDEO CAMERA

PCB mounting pattern



а	1,91	
b	4,45 min.	
С	2,29 min.	
d	d 1,52	
е	0,38 max.	

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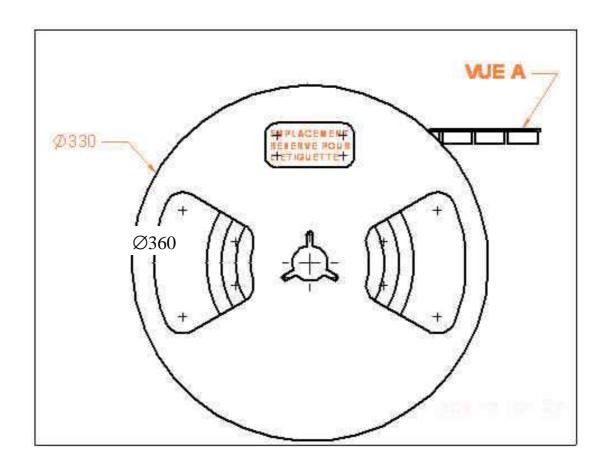
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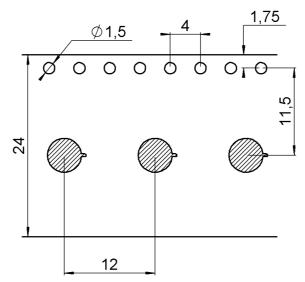


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R222.508.300

Series: SMP





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